

MSX1PB, MSX1PD, MSX1PG, MSX1PJ

Vishay General Semiconductor

AUTOMOTIVE

RoHS

COMPLIANT

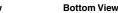
HALOGEN

FREE

Surface-Mount ESD Capability Rectifier

eSMP® Series

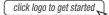




MicroSMP (DO-219AD)



DESIGN SUPPORT TOOLS





| PRIMARY CHARACTERISTICS | | | | | |
|---|----------------------------|--|--|--|--|
| I _{F(AV)} | 1.0 A | | | | |
| V _{RRM} | 100 V, 200 V, 400 V, 600 V | | | | |
| I _{FSM} | 18 A | | | | |
| V _F at I _F = 1.0 A (125 °C) | 0.9 V | | | | |
| T _J max. | 175 °C | | | | |
| Package | MicroSMP (DO-219AD) | | | | |
| Circuit configuration | Single | | | | |

FEATURES

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, polarity protection, and rail-to-rail protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free and RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | | | |
|---|-----------------------------------|-------------|--------|--------|--------|------|--|
| PARAMETER | SYMBOL | MSX1PB | MSX1PD | MSX1PG | MSX1PJ | UNIT | |
| Device marking code | | XB | XD | XG | XJ | | |
| Maximum repetitive peak reverse voltage | V _{RRM} 100 200 400 600 | | 600 | V | | | |
| Maximum average forward rectified current | I _{F(AV)} | 1.0 | | | | Α | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 18 | | | | Α | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +175 | | | | °C | |



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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | | |
|---|---|---|-------------------------------|------|------|------|--|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT | |
| | I _F = 0.5 A | T _A = 25 °C T _A = 125 °C | V _F ⁽¹⁾ | 0.93 | - | V | |
| Maximum instantaneous forward voltage | $I_F = 1.0 A$ | | | 1.0 | 1.1 | | |
| | $I_F = 0.5 A$ | | | 0.81 | - | | |
| | I _F = 1.0 A | | | 0.9 | 0.98 | | |
| Maximum reverse current | Rated V _R | T _A = 25 °C | I _R ⁽²⁾ | - | 1.0 | μA | |
| Maximum reverse current | nated V _R | T _A = 125 °C | | 4.1 | 50 | | |
| Typical reverse recovery time | $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$ | | t _{rr} | 960 | - | ns | |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 5 | = | pF | |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|---------------------------------------|----|------|--|------|------|
| PARAMETER | SYMBOL MSX1PB MSX1PD MSX1PG MSX1PJ UN | | | | UNIT | |
| Typical thermal resistance | R _{0JA} (1) | | °C/W | | | |
| Typical thermal resistance | R _{0JL} (1) | 30 | | | | C/VV |

Note

(1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 5.0 mm x 5.0 mm copper pad areas. R_{θJL} is measured at the terminal of cathode band

| IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$, unless otherwise noted) | | | | | | |
|--|---|---|----------------|-------|------------|--|
| STANDARD | TEST TYPE | TEST CONDITIONS | SYMBOL | CLASS | VALUE | |
| AEC-Q101-001 | Human body model (contact mode) | C = 100 pF, R = 1.5 kΩ | | НЗВ | > 8 kV | |
| AEC-Q101-002 | Machine model (contact mode) | C = 200 pF, R = 0 Ω | | M4 | > 400 V | |
| JESD 22-A114 | Human body model (contact mode) | C = 100 pF, R = 1.5 kΩ | | 3B | > 8 kV | |
| JESD 22-A115 | Machine model (contact mode) | C = 200 pF, R = 0 Ω | V _C | С | > 400 V | |
| IEC 61000-4-2 (2) | Human body model (contact mode) | C = 150 pF, R = 330 Ω | | 4 | > 8 kV | |
| IEC 61000-4-2 (=) | Human body model (air-discharge mode) (1) | C = 150 pF, R = 330 Ω | | 4 | > 15 kV | |
| ISO 10605 | Contact mode | $C = 330 \text{ pF}, R = 2 \text{ k}\Omega$ | | - | 20 kV typ. | |

Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 30 kV

⁽²⁾ System ESD standard

| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-----------------|------------------------|---------------|-----------------------------------|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| MSX1PJ-M3/89A | 0.006 | 89A | 4500 | 7" diameter plastic tape and reel | |
| MSX1PJHM3/89A (1) | 0.006 | 89A | 4500 | 7" diameter plastic tape and reel | |

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

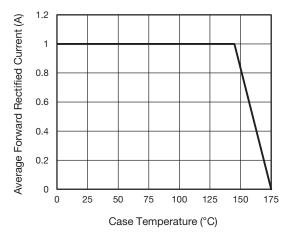


Fig. 1 - Maximum Forward Current Derating Curve

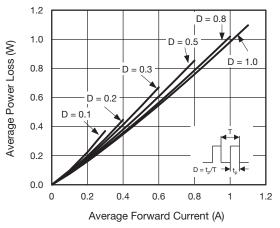


Fig. 2 - Average Power Loss Characteristics

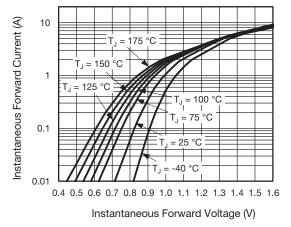


Fig. 3 - Typical Instantaneous Forward Characteristics

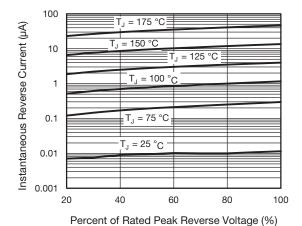


Fig. 4 - Typical Reverse Leakage Characteristics

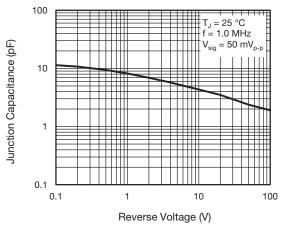


Fig. 5 - Typical Junction Capacitance

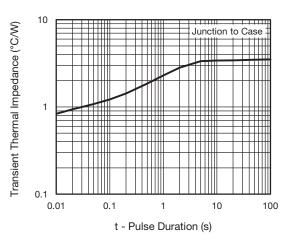


Fig. 6 - Typical Transient Thermal Impedance

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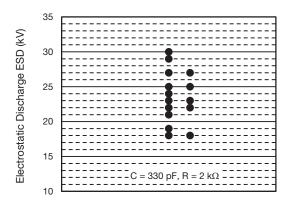
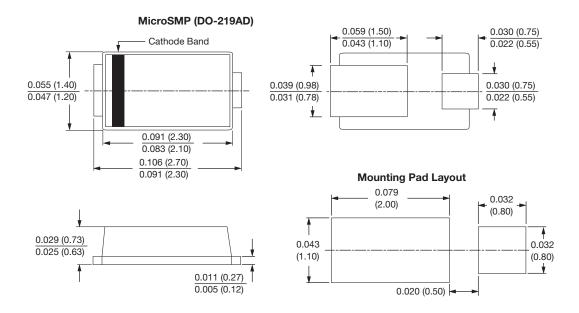


Fig. 7 - ESD Dispersion Map

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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